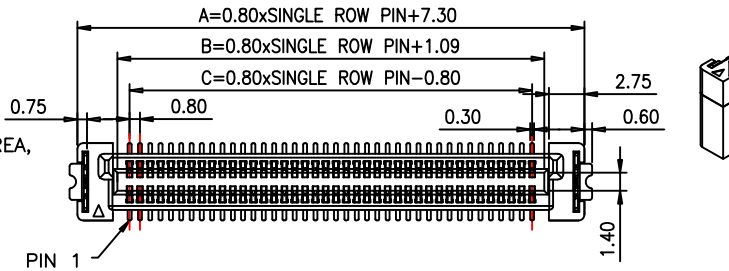
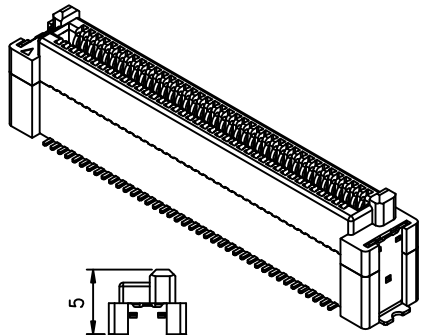
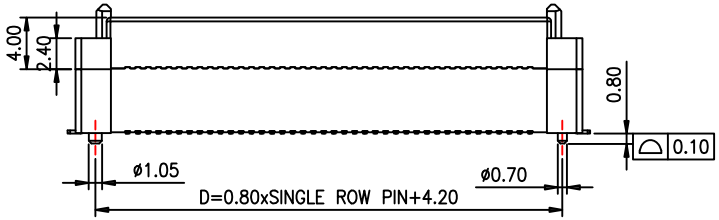
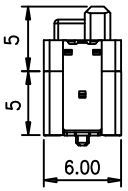
更改 REV	說 變 內 容 MODIFICATION
A	ECXXXXX

NOTES:
1. FINISH:
   1.1 HOUSING: LCP BLACK,UL94V-0.
   1.2 CONTACT: PHOSPHOR BRONZE,GOLD (SEE P/N) PLATED IN CONTACT AERA, 80u" MIN MATTE TIN PLATED IN SOLDER AREA, 50u" MIN. NICKEL UNDERPLATED OVERALL.
   1.3 GROUND: BRASS,80u" MIN. MATTE TIN PLATED OVER 50u" MIN. NICKEL UNDERPLATED OVERALL.
2. ELECTRICAL:
   2.1 CURRENT RATING:0.5A;
   2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC/MINUTE.
   2.3 CONTACT RESISTANCE: 50mΩ MAX.
   2.4 INSULATION RESISTANCE: 1000MΩ MIN.
   2.5 OPERATION TEMPERATURE:-40°C TO +105°C.







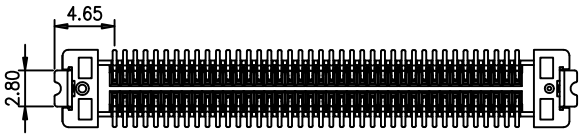


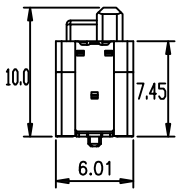
7BTBF-F0-0850XXX

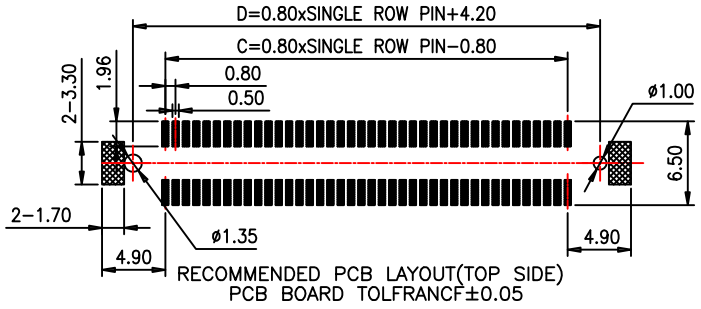
PIN NO:EX:40PIN-040；50PIN-050...

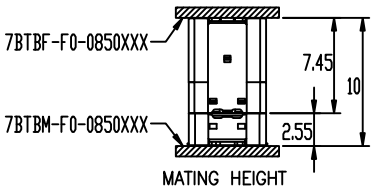
TABLE1:

No. OF PIN	A	B	C	D
040:2x20PIN	23.30	17.09	15.20	20.20
050:2x25PIN	27.30	21.09	19.20	24.20
060:2x30PIN	31.30	25.09	23.20	28.20
080:2x40PIN	39.30	33.09	31.20	36.20
140:2x70PIN	63.30	57.09	55.20	60.20









RoHS

GENERIAL TOLERANCE		KINGCONN 皇海科技股份有限公司		
X.± 0.50	X.°± 5 °			
.X± 0.30	.X°± 2 °	名 稱(TITLE) 0.8 PITCH BTB SOCKET H:5.0 MATING HEIGHT 10.0		
.XX± 0.20	.XX°± 1 °			
單 位(UNIT) mm		料 號(PART NO.) 7BTBF-F0-0850XXX	圖 號(DWG NO.) 7BTBF-F0-0850XXX	
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	比 例 SCALE 1:1	張 數 SHEET 1 / 1
			投 影 PROJ.	更 改 REV A